# CONTENTS

Physical phenomena and effects being characteristic for the contact and noncontact operation regimes of the scanning probe microscopy, are discussed on an elementary level. A theoretical description and numerical estimations of energies, forces and other physical characteristics of contacts are given. Some applications and perspectives for future development of the scanning probe technique with regards to physics and nanotechnology are discussed.

The ultrasonic (US) system of visualization of the high sanction attractive owing to an opportunity to observe a microstructure in volume of opaque objects is described and to measure elastic, viscous and relaxational properties of small areas and inclusions. Results of the control of the connected substrates which in the further will form structure "silicon on insulator" (SOI) are presented.

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Formation of diamond-like material films being obtained by plasma-methods occurs under condition of morphological instability of boundary growth forms. Coherence-breaking for such solid-state systems can be carried out by different relaxation mechanisms that is conditioned on ability to decrease total energy by internal sub-structure selection, coherent phases relative position and optimization of morphological forms. Sputtering methods, especially magnetron sputtering, are irreplaceable for the formation of nanostructured films on large substrate area of amorphous and polycrystalline materials. Spice — modeling and parameter extraction is an important issue at the providing appropriate and reliable semi-conductor device models, including microsystem device models. This paper presents description and analysis different methods of extraction semi-conductor device models.

**Safronov A. Ya., Gornev E. S., Zaitsev N. A., Matyushkin I. V.** The Development of a Design and Manufacturing Techniques for Microsystems on the Basis of Bulk Silicon and Thin Films

The opportunity of application in microelectromechanical systems (MEMS) of piezoceramic elements on basis PZT is considered. It is shown, that the most perspective methods of PZT films (thickness is about 1 mkm) fabrication are sol gel technique and magnetron sputtering. By the example of a matrix of the piezoactuated micromirrors, the ways of p-MEMS creation are discussed.

#### **Abramov I. I.** Problems and Principles of Physics and Simulation of Micro- and Nanoelectronics Devices. Part I. Basic Positions . . . 34

The problems, principles and approaches of physical processes simulation of various micro- and nanoelectronics devices are considered. The analysis is based on the physics of open systems.

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The models of bipolar silicon N-shaped optrons were developed. The spectral, transmission characteristics and their temperature dependence are analyzed. The features of silicon N-transistor optrons with shunting of the base-emitter junction and with modulation of the base current are discussed. The results of modeling correspond to experimental data.

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